

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	57	(bolometer) and (crystal near2 lattice)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:23
L2	1	(bolometer) and ((crystal near2 lattice) with electrode)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:30
L3	2	(bolometer) and ((crystal near2 lattice) near2 constant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:31
L4	75	((((thermal) near2 (resistor resistance responsive))) and ((crystal near2 lattice) near2 constant)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:31
L5	71	(bolometer) and (perovskite)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:33
L6	1	(bolometer) and ("Pr.sub.xCa.sub.1-xMnO.sub.3")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:36
L7	0	(bolometer) and ("Pr.sub.?Ca.sub.?MnO.sub.?"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 12:37
L8	4	(bolometer) and (mno)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 13:22

L9	79	"Pr.sub.1-xCa.sub.xMnO.sub.3"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 13:25
L10	50	"Pr.sub.xCa.sub.1-xMnO.sub.3"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 13:26
L11	2	(bolometer) and (pcmo)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 14:16
L12	2	"20020139776".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/01 14:31
S1	1596	"250/338.1".CCLS.	US-PGPUB; USPAT	OR	ON	2008/07/23 13:50
S2	1187323	(method near5 manufactur\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/23 13:51
S3	116	S1 and (method near5 manufactur\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/23 13:51
S4	261	((YASUHIRO) near2 (SHIMADA)).INV.	US-PGPUB; USPAT	OR	ON	2008/07/23 19:09
S5	50	((DAISUKE) near2 (UEDA)).INV.	USPAT; USOCR	OR	ON	2008/07/23 19:09
S6	3	("20020139776"   "4908599"   "6585909"). PN.	US-PGPUB; USPAT	OR	ON	2008/07/24 15:36
S7	1597	"250/338.1".CCLS.	US-PGPUB; USPAT	OR	ON	2008/07/24 15:38
S8	100	S7 and (MOVPE MOVCD OMVPE (chemical adj vapour adj deposition))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/24 15:38

S9	831	(thermal near2 resist\$3) same ((thin adj film) thin-film)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 12:22
S10	148	S9 and (MOVPE MOCVD OMVPE (chemical adj vapour adj deposition))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 12:23
S11	2	("4665008"   "5368687"). PN. OR ("6585909"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/25 17:29
S12	22	("4451327"   "5098516"   "5100499"   "5262001").PN. OR ("5368687").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/25 17:29
S13	1597	"250/338.1".CQLS.	US-PGPUB; USPAT	OR	ON	2008/07/25 17:33
S14	100	S13 and (MOVPE MOCVD OMVPE (chemical adj vapour adj deposition))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 17:33
S15	831	(thermal near2 resist\$3) same ((thin adj film) thin-film)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 17:33
S16	148	S15 and (MOVPE MOCVD OMVPE (chemical adj vapour adj deposition))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 17:33
S17	146	S16 not S14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 17:33
S18	6	S17 and ((infrared ir) near3 (detect\$3 sens\$3 imag\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 17:34

S19	35	S17 and ((infrared ir thermal) near3 (detect\$3 sens\$3 imag\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 17:34
S20	4422	"1" and ((thermal ir infrared) near2 (resistor))	US-PGPUB; USPAT	OR	ON	2008/07/25 18:11
S21	42	S13 and ((thermal ir infrared) near2 (resistor))	US-PGPUB; USPAT	OR	ON	2008/07/25 18:12
S22	9	(grow\$3) with ((thermal ir infrared) near2 (resistor))	US-PGPUB; USPAT	OR	ON	2008/07/25 18:33
S23	49	(grow\$3) same ((thermal ir infrared) near2 (resistor))	US-PGPUB; USPAT	OR	ON	2008/07/25 18:33
S24	486	((((thermal ir infrared) near2 (resistor))) same ((thin adj film) thin-film))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 18:37
S25	102490	(electrode) with ((thin adj film) thin-film)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 18:39
S26	61	S25 and S24	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/25 18:39
S27	7	("4501967"   "5426304"   "5559332"   "5929441").PN. OR ("6326621").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/28 10:12
S28	1947	((((thermal) near2 (resistor resistance responsive))) same ((thin adj film) thin-film))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:38
S29	7	((((thermal) near2 (resistor resistance responsive))) with (grow \$3 near3 electrode))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:39

S30	440	(((thermal) near2 (resistor resistance responsive))) with (grow \$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:41
S31	13	S30 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:41
S32	2	S30 and "250".clas.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:42
S33	57	S28 and "250".clas.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:42
S34	28	(((thermal) near2 (resistor resistance responsive))) same (MOCVD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:45
S35	32	(((thermal ir infrared) near2 (resistor resistance responsive))) same (MOCVD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:51
S36	170387	"250".clas. (MOCVD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:51
S37	252	"250".clas. and (MOCVD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:51
S38	74	(((thermal ir infrared) near2 (resistor resistance responsive detect\$3 imag \$3))) and S37	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/28 15:52

S39	11	("3755678"   "4445050" "4591717"   "4614957" "4639756"   "4731640" "4875084").PN. OR ("6111254").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/28 16:15
S40	12	("3636358"   "3902066" "4028719"   "4198646" "4210922"   "4639756" "4731640" "4875084").PN. OR ("6198100").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/28 19:18
S41	252	"250".das. and (MOCVD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/29 10:28
S42	74	((((thermal ir infrared) near2 (resistor resistance responsive detect\$3 imag \$3))) and \$41	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/29 10:28
S43	41	\$42 and (((thin adj film) thin-film)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/29 10:28
S44	33	("3816750"   "4009516" "5270298"   "5387459").PN. OR ("5684302").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/29 10:37
S45	49	bolometer and mocvd	US-PGPUB; USPAT; USOCR	OR	ON	2008/07/29 11:22
S46	8	(bolometer) and (ion near5 cluster\$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:29
S47	2	(bolometer) and (((liquid adj phase) liquid-phase) near2 growth)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:30
S48	28	(bolometer) and (electrophoresis)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:30

S49	19	(bolometer) and (colloid)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:30
S50	57	(bolometer) and (crystal near2 lattice)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:30
S51	1	S50 and S49 and S48	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:31
S52	1	S50 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:31
S53	2	S50 and S48	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 11:31
S54	19	(bolometer) and (colloid)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/07/31 18:25

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